

# RHRU7540, RHRU7550, RHRU7560

Data Sheet April 1995 File Number 3945.1

# 75A, 400V - 600V Hyperfast Diodes

RHRU7540, RHRU7550 and RHRU7560 (TA49067) are hyperfast diodes with soft recovery characteristics ( $t_{RR} < 55$ ns). They have half the recovery time of ultrafast diodes and are silicon nitride passivated ion-implanted epitaxial planar construction.

These devices are intended for use as freewheeling/clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

# **Ordering Information**

#### **PACKAGING AVAILABILITY**

PART NUMBER	PACKAGE	BRAND		
RHRU7540	TO-218	RHRU7540		
RHRU7550	TO-218	RHRU7550		
RHRU7560	TO-218	RHRU7560		

NOTE: When ordering, use the entire part number.

### **Features**

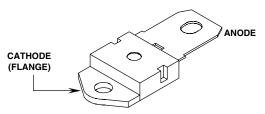
- Avalanche Energy Rated
- Planar Construction

## **Applications**

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

### **Package**

#### **SINGLE LEAD JEDEC STYLE TO-218**



### Symbol



### **Absolute Maximum Ratings** T<sub>C</sub> = +25°C, Unless Otherwise Specified

	RHRU7540	RHRU7550	RHRU7560	UNITS
Peak Repetitive Reverse Voltage	400	500	600	V
Working Peak Reverse Voltage	400	500	600	V
DC Blocking Voltage	400	500	600	V
Average Rectified Forward Current $I_{F(AV)}$ ( $T_C = +80^{\circ}C$ )	75	75	75	Α
Repetitive Peak Surge CurrentI <sub>FSM</sub> (Square Wave, 20kHz)	150	150	150	Α
Nonrepetitive Peak Surge Current	750	750	750	Α
Maximum Power Dissipation	190	190	190	W
Avalanche Energy (See Figures 10 and 11)EAVL	50	50	50	mj
Operating and Storage Temperature	-65 to +175	-65 to +175	-65 to +175	°C

### RHRU7540, RHRU7550, RHRU7560

### **Electrical Specifications** $T_C = +25^{\circ}C$ , Unless Otherwise Specified

		RHRU7540		RHRU7550			RHRU7560				
SYMBOL	TEST CONDITION	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
V <sub>F</sub>	$I_F = 75A$ , $T_C = +25^{\circ}C$	-	-	2.1	-	-	2.1	-	-	2.1	V
	I <sub>F</sub> = 75A, T <sub>C</sub> = +150°C	-	-	1.7	-	-	1.7	-	-	1.7	V
I <sub>R</sub>	$V_R = 400V, T_C = +25^{\circ}C$	-	-	500	-	-	-	-	-	-	μΑ
	$V_R = 500V, T_C = +25^{\circ}C$	-	-	-	-	-	500	-	-	-	μΑ
	$V_R = 600V, T_C = +25^{\circ}C$	-	-	-	-	-	-	-	-	500	μΑ
I <sub>R</sub>	$V_R = 400V, T_C = +150^{\circ}C$	-	-	2.0	-	-	-	-	-	-	mA
	$V_R = 500V, T_C = +150^{\circ}C$	-	-	-	-	-	2.0	-	-	-	mA
	$V_R = 600V, T_C = +150^{\circ}C$	-	-	-	-	-	-	-	-	2.0	mA
t <sub>RR</sub>	$I_F = 1A$ , $dI_F/dt = 100A/\mu s$	-	-	55	-	-	55	-	-	55	ns
	$I_F = 75A$ , $dI_F/dt = 100A/\mu s$	-	-	60	-	-	60	-	-	60	ns
t <sub>A</sub>	$I_F = 75A$ , $dI_F/dt = 100A/\mu s$	-	35	-	-	35	-	-	35	-	ns
t <sub>B</sub>	$I_F = 75A$ , $dI_F/dt = 100A/\mu s$	-	18	-	-	18	-	-	18	-	ns
Q <sub>RR</sub>	$I_F = 75A$ , $dI_F/dt = 100A/\mu s$	-	90	-	-	90	-	-	90	-	nC
CJ	V <sub>R</sub> = 10V, I <sub>F</sub> = 0A	-	200	-	-	200	-	-	200	-	pF
$R_{\theta JC}$		-	-	0.8	-	-	0.8	-	-	0.8	°C/W

#### **DEFINITIONS**

 $V_F$  = Instantaneous forward voltage (pw = 300 $\mu$ s, D = 2%).

I<sub>R</sub> = Instantaneous reverse current.

 $t_{RR}$  = Reverse recovery time (See Figure 2), summation of  $t_A + t_B$ .

 $t_A$  = Time to reach peak reverse current (See Figure 2).

t<sub>B</sub> = Time from peak I<sub>RM</sub> to projected zero crossing of I<sub>RM</sub> based on a straight line from peak I<sub>RM</sub> through 25% of I<sub>RM</sub> (See Figure 2).

Q<sub>RR</sub> = Reverse recovery charge.

C<sub>J</sub> = Junction Capacitance.

 $R_{\theta JC}$  = Thermal resistance junction to case.

 $E_{AVL}$  = Controlled avalanche energy. (See Figures 10 and 11).

pw = pulse width.

D = duty cycle.

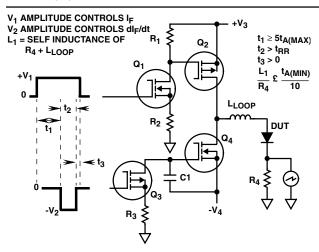


FIGURE 1. t<sub>RR</sub> TEST CIRCUIT

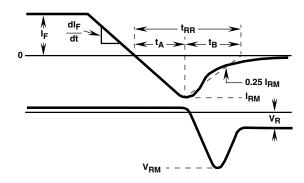


FIGURE 2. t<sub>RR</sub> WAVEFORMS AND DEFINITIONS

# **Typical Performance Curves**

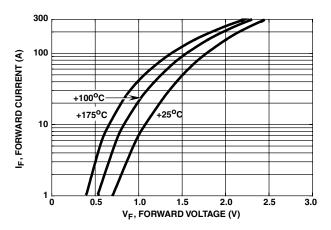


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

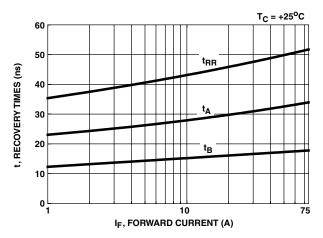


FIGURE 5. TYPICAL  $t_{RR}$ ,  $t_{A}$  AND  $t_{B}$  CURVES vs FORWARD CURRENT AT +25°C

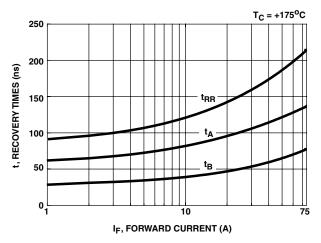


FIGURE 7. TYPICAL  $t_{RR}$ ,  $t_{A}$  AND  $t_{B}$  CURVES vs FORWARD CURRENT AT +175°C

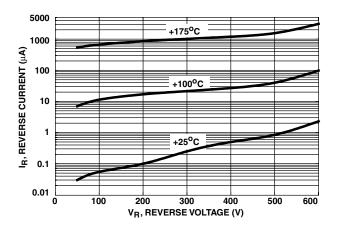


FIGURE 4. TYPICAL REVERSE CURRENT vs REVERSE VOLTAGE

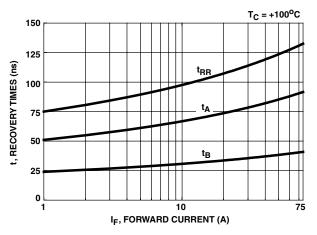


FIGURE 6. TYPICAL  $t_{RR}$ ,  $t_{A}$  AND  $t_{B}$  CURVES vs FORWARD CURRENT AT +100°C

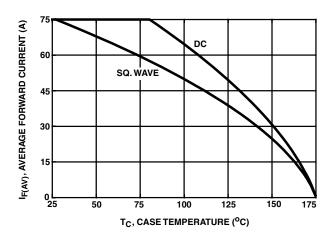


FIGURE 8. CURRENT DERATING CURVE FOR ALL TYPES

# Typical Performance Curves (Continued)

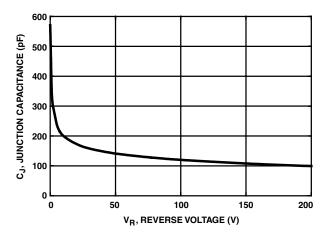
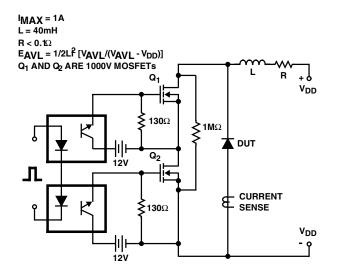


FIGURE 9. TYPICAL JUNCTION CAPACITANCE vs REVERSE VOLTAGE

# **Test Circuit and Waveforms**





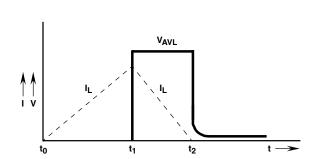


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORM

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DOME™	ISOPLANAR™	QT Optoelectronics™	UHC <sup>TM</sup>
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E <sup>2</sup> CMOS <sup>TM</sup>	MicroFET™	SILENT SWITCHER ®	$VCX^{TM}$
EnSigna™	MICROWIRE™	SMART START™	

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